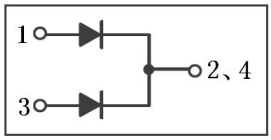
/ Descriptions

TO-252 ≈

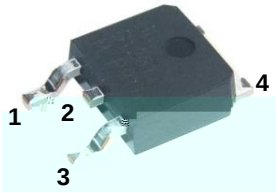
/ Features

/ Applications

/ Equivalent Circuit

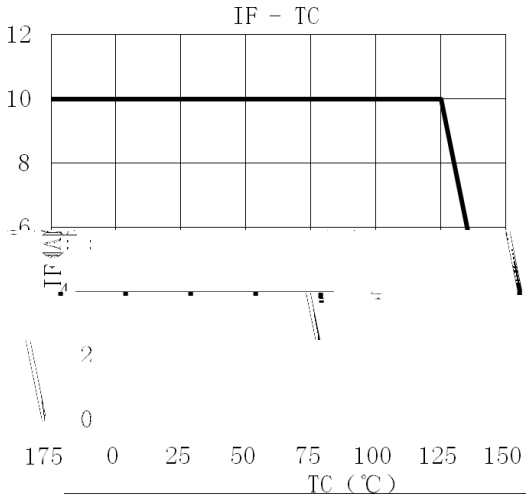


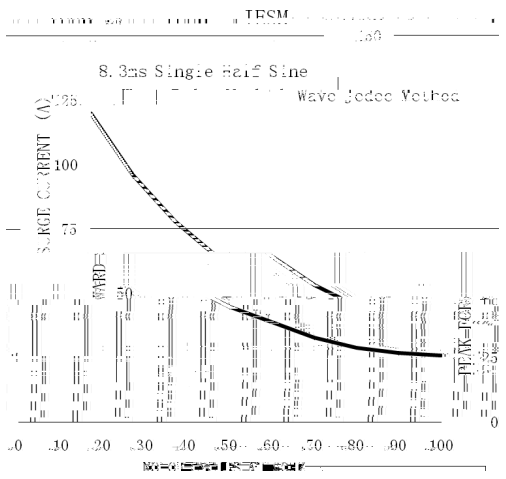
/ Pinning

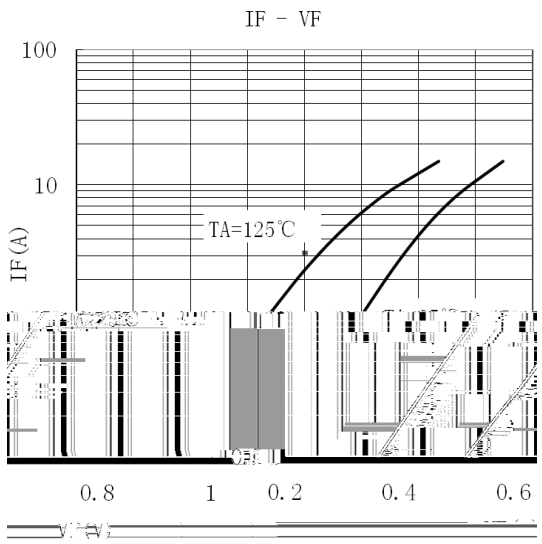


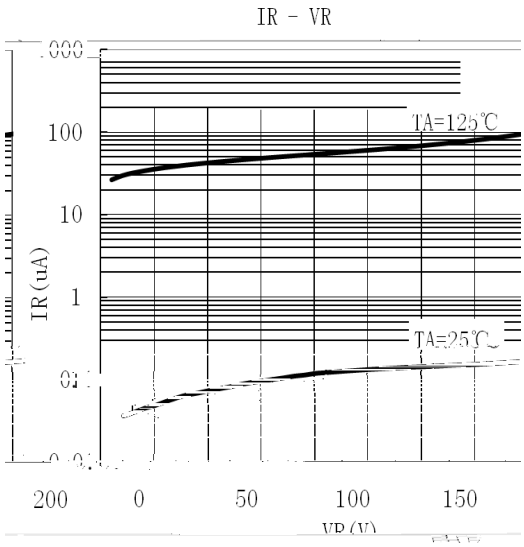
/ h_{FE} Classifications & Marking

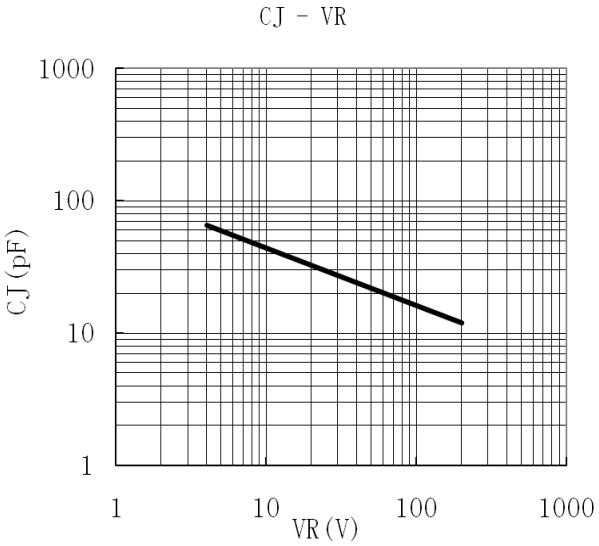
/ Electrical Characteristic Curve



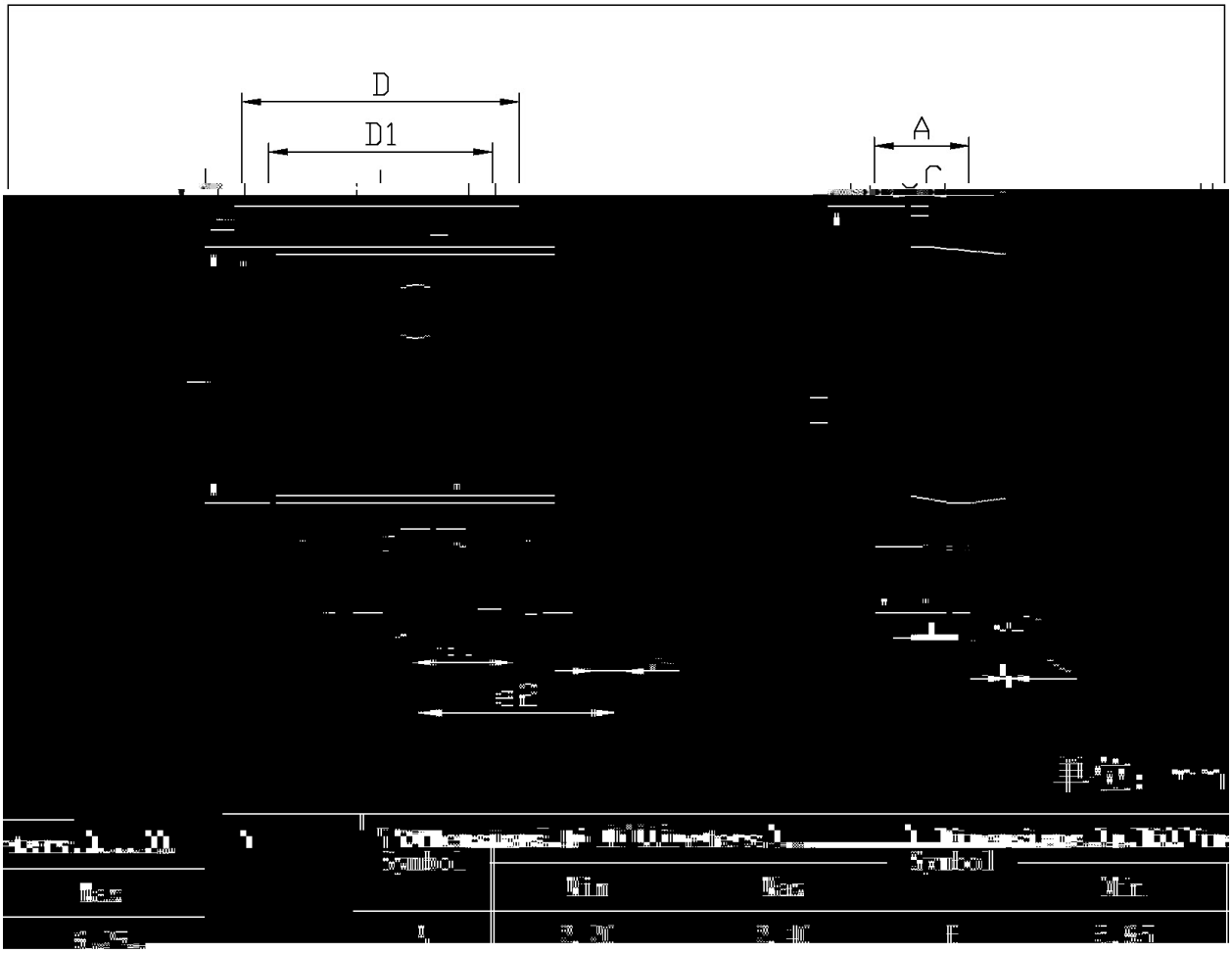








/ Package Dimensions

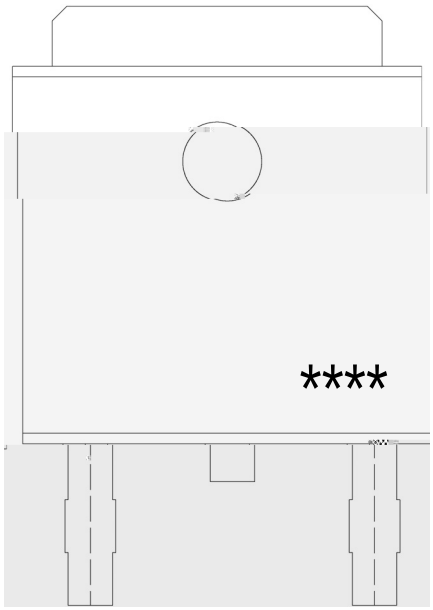


Symbol	Min	Max	Symbol	Min

00	0.10	D1	5.10	5.50	K

TO-252

/ Marking Instructions



BR

MBRD10200

CT:

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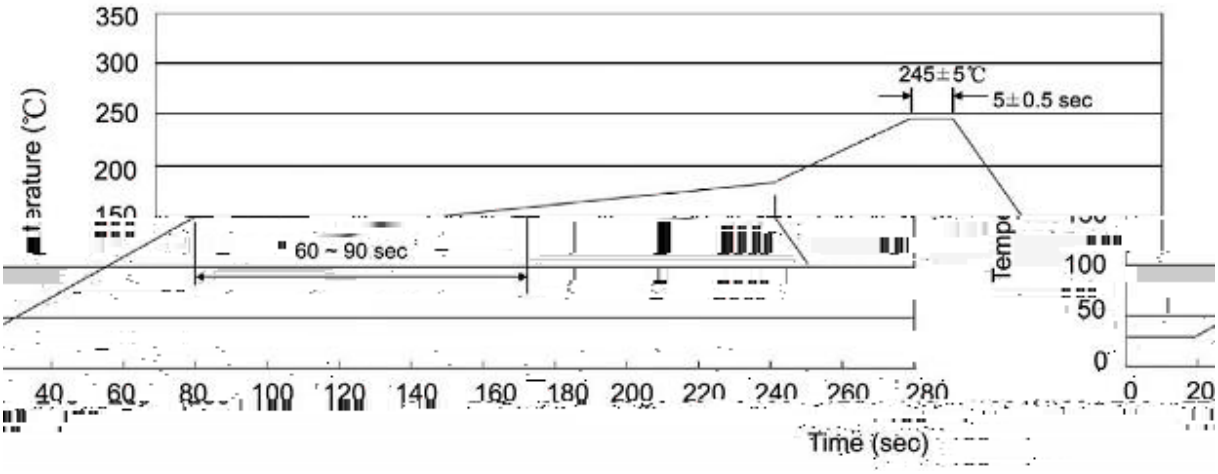
MBRD10200

CT:

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box